DATA SHEET

74ABT16652 74ABTH16652

16-bit transceiver/register, non-inverting (3-State)

Product specification
Supersedes data of 1995 Aug 17
IC23 Data Handbook





16-bit transceiver/register, non-inverting (3-State)

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FEATURES

- Independent registers for A and B buses
- Multiple V_{CC} and GND pins minimize switching noise
- Power-up 3-State
- 74ABTH16652 incorporates bus-hold data inputs which eliminate the need for external pull-up resistors to hold unused inputs
- Power-up reset
- Live insertion/extraction permitted
- Multiplexed real-time and stored data
- Output capability: +64mA/-32mA
- Latch-up protection exceeds 500mA per JEDEC Std 17
- ESD protection exceeds 2000V per MIL STD 883 Method 3015 and 200V per Machine Model

DESCRIPTION

The 74ABT16652 high-performance BiCMOS device combines low static and dynamic power dissipation with high speed and high output drive.

The 74ABT16652 transceiver/register consists of two sets of bus transceiver circuits with 3-State outputs, D-type flip-flops, and control circuitry arranged for multiplexed transmission of data directly from the input bus or the internal registers. Data on the A or B bus will be clocked into the registers as the appropriate clock pin goes HIGH. Output Enable (nOEAB, (nOEBA) and Select (nSAB, nSBA) pins are provided for bus management.

Two options are available, 74ABT16652 which does not have the bus-hold feature and 74ABTH16652 which incorporates the bus-hold feature.

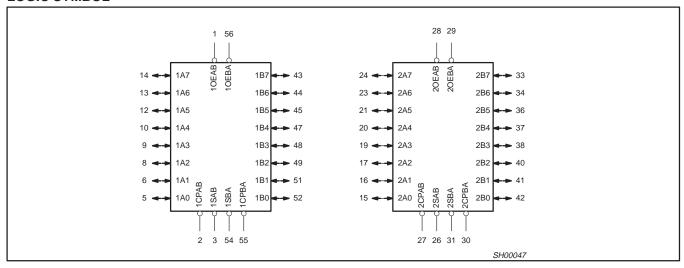
QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS T _{amb} = 25°C; GND = 0V	TYPICAL	UNIT
t _{PLH} t _{PHL}	Propagation delay nAx to nBx	$C_L = 50pF; V_{CC} = 5V$	2.3 1.8	ns
C _{IN}	Input capacitance	V _I = 0V or V _{CC}	4	pF
C _{I/O}	I/O capacitance	V _O = 0V or V _{CC} ; 3-State	7	pF
I _{CCZ}	Quiescent supply current	Outputs disabled; V _{CC} =5.5V	500	μΑ
I _{CCL}	Quiescent supply current	Outputs low; V _{CC} = 5.5V	8	mA

ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	DWG NUMBER	
56-Pin Plastic SSOP Type III	-40°C to +85°C	74ABT16652 DL	BT16652 DL	SOT371-1	
56-Pin Plastic TSSOP Type II	-40°C to +85°C	74ABT16652 DGG	BT16652 DGG	SOT364-1	
56-Pin Plastic SSOP Type III	-40°C to +85°C	74ABTH16652 DL	BH16652 DL	SOT371-1	
56-Pin Plastic TSSOP Type II	-40°C to +85°C	74ABTH16652 DGG	BH16652 DGG	SOT364-1	

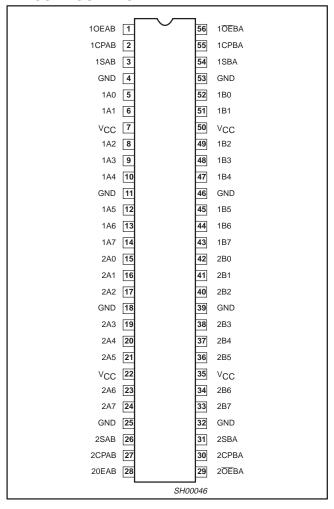
LOGIC SYMBOL



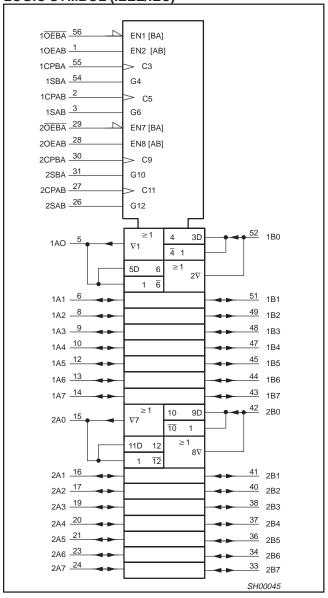
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PIN CONFIGURATION



LOGIC SYMBOL (IEEE/IEC)



PIN DESCRIPTION

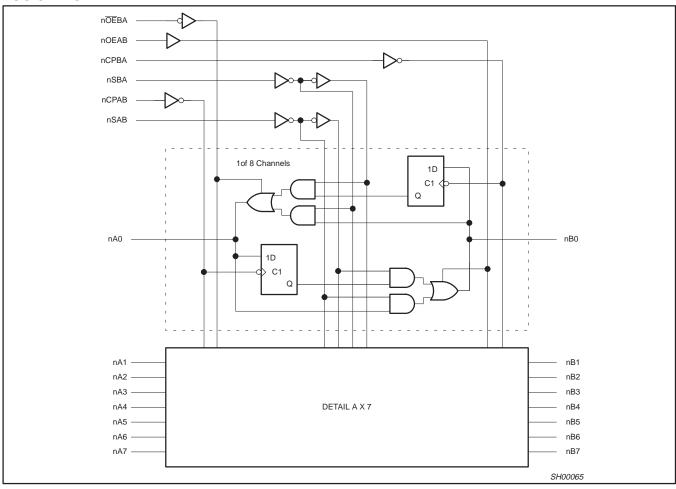
I IN DESCRIPTION		
PIN NUMBER	SYMBOL	NAME AND FUNCTION
2, 55, 27, 30	1CPAB, 1CPBA, 2CPAB, 2CPBA	Clock input A to B / Clock input B to A
3, 54, 26, 31	1SAB, 1SBA, 2SAB, 2SBA	Select input A to B / Select input B to A
5, 6, 8, 9, 10, 12, 13, 14 15, 16, 17, 19, 20, 21, 23, 24	1A0 – 1A7, 2A0 – 2A7	Data inputs/outputs (A side)
52, 51, 49, 48, 47, 45, 44, 43 42, 41, 40, 38, 37, 36, 34, 33	1B0 – 1B7, 2B0 – 2B7	Data inputs/outputs (B side)
1, 56, 28, 29	10EAB, 1 <u>0EBA,</u> 20EAB, 2 <u>0EBA</u>	Output enable inputs
4, 11, 18, 25, 32, 39, 46, 53	GND	Ground (0V)
7, 22, 35, 50	V _{CC}	Positive supply voltage

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LOGIC DIAGRAM



FUNCTION TABLE

		INPUT	3		·	DATA	A I/O	OPERATING MODE
nOEAB	nOEBA	nCPAB	nCPBA	nSAB	nSB A	nAx	nBx	
L L	H H	H or L ↑	H or L ↑	X	X	Input	Input	Isolation Store A and B data
X H	H H	↑	H or L ↑	X **	X X	Input	Unspecified output*	Store A, Hold B Store A in both registers
L L	X L	H or L ↑	↑	X	X **	Unspecified output*	Input	Hold A, Store B Store B in both registers
L L	L L	X X	X H or L	X	L H	Output	Input	Real time B data to A bus Stored B data to A bus
H H	H H	X H or L	X X	L H	X	Input	Output	Real time A data to B bus Store A data to B bus
Н	L	H or L	H or L	Н	Н	Output	Output	Stored A data to B bus Stored B data to A bus

H = High voltage level

_ = Low voltage level

X = Don't care

↑ = Low-to-High clock transition

The data output function may be enabled or disabled by various signals at the nOEBA and nOEAB inputs. Data input functions are always enabled, i.e., data at the bus pins will be stored on every Low-to-High transition of the clock.

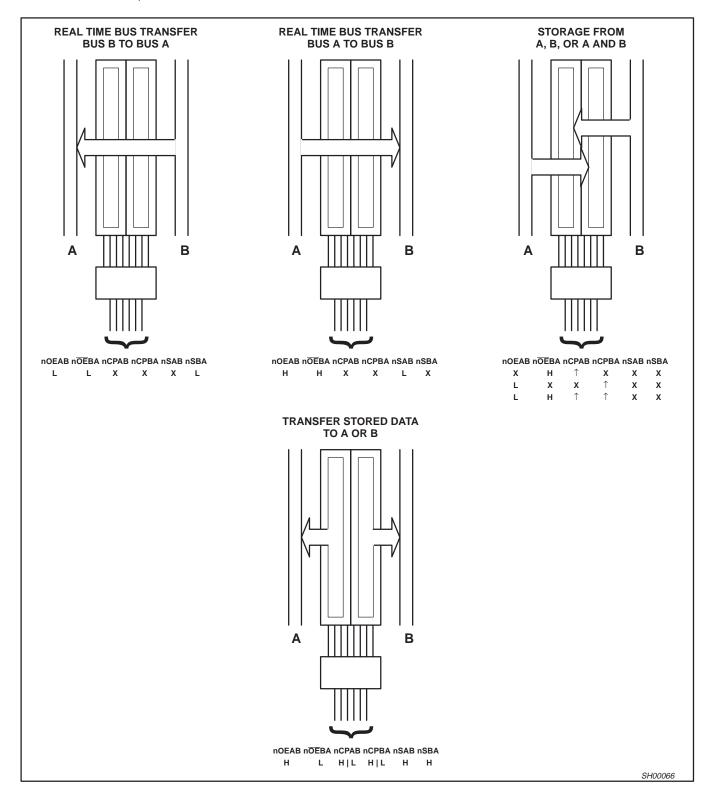
** If both Select controls (nSAB and nSBA) are Low, then clocks can occur simultaneously. If either Select control is High, the clocks must be staggered in order to load both registers.

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The following examples demonstrate the four fundamental bus-management functions that can be performed with the 74ABT16652.The select pins determine whether data is stored or

transferred through the device in real time. The output enable pins determine the direction of the data flow.



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ABSOLUTE MAXIMUM RATINGS^{1, 2}

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT	
V _{CC}	DC supply voltage		-0.5 to +7.0	V	
I _{IK}	DC input diode current	V _I < 0	-18	mA	
VI	DC input voltage ³		-1.2 to +7.0	V	
I _{OK}	DC output diode current V _O < 0		-50	mA	
V _{OUT}	DC output voltage ³	output in Off or HIGH state	-0.5 to +5.5	V	
1	DC output ourront	output in LOW state	128	mA	
Гоит	DC output current	output in HIGH state	-64	l IIIA	
T _{stg}	Storage temperature range		-65 to 150	°C	

NOTES:

1. Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150°C.

3. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	LIM	UNIT	
STWIBOL	FARAMETER	MIN	MAX	UNIT
V _{CC}	DC supply voltage	4.5	5.5	V
VI	Input voltage	0	V _{CC}	V
V _{IH}	High-level input voltage	2.0		V
V _{IL}	Low-level Input voltage		0.8	V
I _{OH}	High-level output current		-32	mA
I _{OL}	Low-level output current		64	mA
Δt/Δν	Input transition rise or fall rate	0	10	ns/V
T _{amb}	Operating free-air temperature range	-40	+85	°C

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DC ELECTRICAL CHARACTERISTICS

					LIMITS			
PARAMETER	TEST CONDITIONS		T _a	_{mb} = +25	i∘C	T _{amb} =	: –40°C 85°C	UNIT
			MIN	TYP	MAX	MIN	MAX	
Input clamp voltage	$V_{CC} = 4.5V; I_{IK} = -18mA$			-0.9	-1.2		-1.2	V
	$V_{CC} = 4.5V; I_{OH} = -3mA; V_I = V_{II}$	or V _{IH}	2.5	2.9		2.5		V
High-level output voltage	$V_{CC} = 5.0V; I_{OH} = -3mA; V_{I} = V_{II}$	or V _{IH}	3.0	4.0		3.0		V
	$V_{CC} = 4.5V$; $I_{OH} = -32mA$; $V_I = V_{IL}$ or V_{IH}		2.0	2.4		2.0		V
Low-level output voltage	$V_{CC} = 4.5V; I_{OL} = 64mA; V_{I} = V_{II}$		0.35	0.55		0.55	V	
Power-up output low voltage ³	$V_{CC} = 5.5V; I_{OL} = 1mA; V_{I} = GNE$	or V _{CC}		0.13	0.55		0.55	V
Input leakage current	$V_{CC} = 5.5V$; $V_I = GND$ or V_{CC}	Control pins		±0.01	±1.0		±1.0	μΑ
	$V_{CC} = 4.5V; V_I = 0.8V$		35			35		
Bus Hold current A or B Ports ⁵ 74ABTH16652	$V_{CC} = 4.5V; V_I = 2.0V$ -75		-75			- 75		μΑ
	$V_{CC} = 5.5V$; $V_I = 0$ to $5.5V$		±800					1
Power-off leakage current	$V_{CC} = 0V; V_{O} = 4.5V; V_{I} = 0V o$	r 5.5V		±1.0	±100		±100	μА
Power-up/down 3-State output current ⁴	$V_{CC} = 2.1V; V_{O} = 0.0V; V_{I} = GND$	or V _{CC}		±1.0	±50		±50	μА
3-State output High current	$V_{CC} = 5.5V; V_O = 5.5V; V_I = V_{IL}$	or V _{IH}		1.0	10		10	μΑ
3-State output Low current	$V_{CC} = 5.5V; V_{O} = 0.0V; V_{I} = V_{IL}$	or V _{IH}		-1.0	-10		-10	μΑ
Output High leakage current	$V_{CC} = 5.5V; V_O = 5.5V; V_I = GNE$	or V _{cc}		5.0	50		50	μΑ
Output current ¹	$V_{CC} = 5.5V; V_{O} = 2.5V$		-50	-80	-180	-50	-180	mA
	V_{CC} = 5.5V; Outputs High, V_{I} = GND or V_{CC}			0.5	2		2	mA
Quiescent supply current	$V_{CC} = 5.5V$; Outputs Low, $V_I = GN$	D or V _{CC}		8	19		19	mA
]	V_{CC} = 5.5V; Outputs 3-State V_{I} = GND or V_{CC}		0.5	2		2	mA	
Additional supply current per input pin ² 74ABT16652	V_{CC} = 5.5V; one input at 3.4 other inputs at V_{CC} or GNI		5.0	50		50	μА	
Additional supply current per input pin ² 74ABTH16652	V_{CC} = 5.5V; one input at 3.4 other inputs at V_{CC} or GNI	V, D		200	500		500	μΑ
	Input clamp voltage High-level output voltage Low-level output voltage Power-up output low voltage ³ Input leakage current Bus Hold current A or B Ports ⁵ 74ABTH16652 Power-off leakage current Power-up/down 3-State output current ⁴ 3-State output High current Output High leakage current Output durrent ¹ Quiescent supply current Additional supply current per input pin ² 74ABT16652 Additional supply current per input pin ² 74ABT16652 Additional supply current per input pin ²	Input clamp voltage	Input clamp voltage	Input clamp voltage $V_{CC} = 4.5V; \ l_{IK} = -18\text{mA}$ $V_{CC} = 4.5V; \ l_{OH} = -3\text{mA}; \ V_1 = V_{IL} \text{ or } V_{IH} \qquad 2.5$ $V_{CC} = 5.0V; \ l_{OH} = -3\text{mA}; \ V_1 = V_{IL} \text{ or } V_{IH} \qquad 3.0$ $V_{CC} = 4.5V; \ l_{OH} = -3\text{mA}; \ V_1 = V_{IL} \text{ or } V_{IH} \qquad 3.0$ $V_{CC} = 4.5V; \ l_{OH} = -32\text{mA}; \ V_1 = V_{IL} \text{ or } V_{IH} \qquad 2.0$ $V_{CC} = 4.5V; \ l_{OH} = -32\text{mA}; \ V_1 = V_{IL} \text{ or } V_{IH} \qquad 2.0$ $V_{CC} = 4.5V; \ l_{OL} = 64\text{mA}; \ V_1 = V_{IL} \text{ or } V_{IH} \qquad 2.0$ $V_{CC} = 5.5V; \ l_{OL} = 1\text{mA}; \ V_1 = G\text{ND or } V_{CC} \qquad Control pins$ $V_{CC} = 5.5V; \ V_1 = 0\text{ND or } V_{CC} \qquad Control pins$ $V_{CC} = 4.5V; \ V_1 = 0.8V \qquad 35$ $V_{CC} = 4.5V; \ V_1 = 0.8V \qquad 35$ $V_{CC} = 4.5V; \ V_1 = 0.8V \qquad 35$ $V_{CC} = 4.5V; \ V_1 = 0.8V \qquad 35$ $V_{CC} = 4.5V; \ V_1 = 0.00 \qquad 7.5$ $V_{CC} = 5.5V; \ V_1 = 0 \text{ to } 5.5V \qquad 2800$ $V_{CC} = 5.5V; \ V_1 = 0 \text{ to } 5.5V \qquad 2800$ $V_{CC} = 5.5V; \ V_1 = 0 \text{ to } 5.5V \qquad 2800$ $V_{CC} = 2.1V; \ V_0 = 0.0V; \ V_1 = G\text{ND or } V_{CC} \qquad 3.5$ $2.5 \text{ tate output High current} \qquad V_{CC} = 5.5V; \ V_0 = 5.5V; \ V_1 = V_{IL} \text{ or } V_{IH} \qquad 3.0$ $V_{CC} = 5.5V; \ V_0 = 5.5V; \ V_0 = 5.5V; \ V_1 = G\text{ND or } V_{CC} \qquad 3.5$ $V_{CC} = 5.5V; \ V_0 = 5.5V; \ V_0 = 5.5V; \ V_0 = 2.5V \qquad -50$ $V_{CC} = 5.5V; \ V_0 = 5.5V; \ V_0 = 5.5V; \ V_0 = 2.5V \qquad -50$ $V_{CC} = 5.5V; \ Outputs \ High, \ V_1 = G\text{ND or } V_{CC} \qquad 3.5$ $V_{CC} = 5.5V; \ Outputs \ High, \ V_1 = G\text{ND or } V_{CC} \qquad 3.5$ $V_{CC} = 5.5V; \ Outputs \ High, \ V_1 = G\text{ND or } V_{CC} \qquad 3.5$ $V_{CC} = 5.5V; \ Outputs \ S.5$ $V_{CC} = 5.5V; \ Outputs \ 3.5$ $V_{CC} = 5.5V; \ Outputs \ 3.4V, \ Other \ inputs \ at \ 3.4V, \ Other \ inputs \ at \ 3.4V, \ Other \ inputs \ at \ 3.4V, \ Oth$	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	$ \begin{array}{ c c c c c } \hline \textbf{PARAMETER} & \textbf{TEST CONDITIONS} & \textbf{T}_{amb} = +25^{\circ}C \\ \hline \textbf{MIN} & \textbf{TYP} & \textbf{MAX} \\ \hline \textbf{Input clamp voltage} & V_{CC} = 4.5V; I_{IK} = -18mA & -0.9 & -1.2 \\ \hline \textbf{High-level output voltage} & V_{CC} = 4.5V; I_{OH} = -3mA; V_1 = V_{IL} \text{ or } V_{IH} & 2.5 & 2.9 \\ \hline \textbf{V}_{CC} = 5.0V; I_{OH} = -3mA; V_1 = V_{IL} \text{ or } V_{IH} & 3.0 & 4.0 \\ \hline \textbf{V}_{CC} = 4.5V; I_{OH} = -32mA; V_1 = V_{IL} \text{ or } V_{IH} & 0.35 & 0.55 \\ \hline \textbf{Power-up output low} & V_{CC} = 4.5V; I_{OL} = 64mA; V_1 = V_{IL} \text{ or } V_{IH} & 0.35 & 0.55 \\ \hline \textbf{Power-up output low} & V_{CC} = 5.5V; V_0 = 1mA; V_1 = GND \text{ or } V_{CC} & 0.13 & 0.55 \\ \hline \textbf{Input leakage current} & V_{CC} = 5.5V; V_1 = 0 \text{ ND or } V_{CC} & 0.13 & 0.55 \\ \hline \textbf{Input leakage current} & V_{CC} = 4.5V; V_1 = 0.8V & 35 & 0.55 \\ \hline \textbf{V}_{CC} = 4.5V; V_1 = 0.8V & 35 & 0.55 \\ \hline \textbf{V}_{CC} = 4.5V; V_1 = 0.8V & 35 & 0.55 \\ \hline \textbf{Power-up/down 3-State} & V_{CC} = 4.5V; V_1 = 0 \text{ to } 5.5V & \pm 800 \\ \hline \textbf{V}_{CC} = 5.5V; V_0 = 0.0V; V_0 = 4.5V; V_1 = 0V \text{ or } 5.5V & \pm 1.0 & \pm 100 \\ \hline \textbf{S-State output High current} & V_{CC} = 5.5V; V_0 = 5.5V; V_1 = SND \text{ or } V_{CC} & \pm 1.0 & \pm 50 \\ \hline \textbf{Output current}^1 & V_{CC} = 5.5V; V_0 = 0.0V; V_1 = GND \text{ or } V_{CC} & 5.0 & 50 \\ \hline \textbf{Output current}^1 & V_{CC} = 5.5V; V_0 = 5.5V; V_1 = SND \text{ or } V_{CC} & 5.0 & 50 \\ \hline \textbf{Output current}^1 & V_{CC} = 5.5V; V_0 = 5.5V; V_1 = GND \text{ or } V_{CC} & 5.0 & 50 \\ \hline \textbf{Output current}^1 & V_{CC} = 5.5V; Outputs High, V_1 = GND \text{ or } V_{CC} & 5.0 & 50 \\ \hline \textbf{Output current}^1 & V_{CC} = 5.5V; Outputs High, V_1 = GND \text{ or } V_{CC} & 5.0 & 50 \\ \hline \textbf{V}_{CC} = 5.5V; Outputs S-State; V_1 = GND \text{ or } V_{CC} & 5.0 & 50 \\ \hline \textbf{Additional supply current} & V_{CC} = 5.5V; \text{ one input at } 3.4V, \text{ other inputs at } 3.4V, oth$	$ \begin{array}{ c c c c c } \hline \textbf{PARAMETER} & \textbf{TEST CONDITIONS} & \hline & \textbf{T}_{amb} = +25^{\circ} \mathbb{C} & \hline & \textbf{MiN} & \textbf{MIN} & \hline & \textbf{MIN} & $	$ \begin{array}{ c c c c c } \hline \textbf{PARAMETER} & \textbf{TEST CONDITIONS} & \hline & \textbf{T}_{amb} = +25^{\circ}\textbf{C} & \hline & \textbf{T}_{amb} = -40^{\circ}\textbf{C} \\ \hline & \textbf{MIN} & \textbf{TYP} & \textbf{MAX} & \textbf{MIN} & \textbf{MAX} \\ \hline \textbf{Input clamp voltage} & V_{CC} = 4.5V; I_{jK} = -18mA & -0.9 & -1.2 & -1.2 \\ \hline \textbf{High-level output voltage} & V_{CC} = 5.5V; I_{OH} = -3mA; V_1 = V_{IL} \text{ or } V_{IH} & 2.5 & 2.9 & 2.5 \\ \hline \textbf{V}_{CC} = 5.5V; I_{OH} = -3mA; V_1 = V_{IL} \text{ or } V_{IH} & 3.0 & 4.0 & 3.0 \\ \hline \textbf{V}_{CC} = 4.5V; I_{OH} = -3mA; V_1 = V_{IL} \text{ or } V_{IH} & 2.0 & 2.4 & 2.0 \\ \hline \textbf{Low-level output voltage} & V_{CC} = 4.5V; I_{OL} = 64mA; V_1 = V_{IL} \text{ or } V_{IH} & 0.35 & 0.55 & 0.55 \\ \hline \textbf{Power-up output low} & V_{CC} = 5.5V; I_{OL} = 1mA; V_1 = GND \text{ or } V_{CC} & 0.13 & 0.55 & 0.55 \\ \hline \textbf{Input leakage current} & V_{CC} = 5.5V; V_1 = GND \text{ or } V_{CC} & 0.13 & 0.55 & 0.55 \\ \hline \textbf{Input leakage current} & V_{CC} = 5.5V; V_1 = 0.8V & 35 & 35 & 35 \\ \hline \textbf{V}_{CC} = 4.5V; V_1 = 2.0V & -75 & -75 & -75 \\ \hline \textbf{V}_{CC} = 4.5V; V_1 = 0.8V & 35 & 35 & 35 \\ \hline \textbf{V}_{CC} = 4.5V; V_1 = 0.8V & 0.5.5V & \pm 800 & -15 \\ \hline \textbf{Power-up/down 3-State} & V_{CC} = 0V; V_0 = 4.5V; V_1 = 0V \text{ or } 5.5V & \pm 1.0 & \pm 100 \\ \hline \textbf{Dewer-up/down 3-State} & V_{CC} = 0.7; V_0 = 0.0V; V_1 = GND \text{ or } V_{CC} & \pm 1.0 & \pm 50 \\ \hline \textbf{3-State output High current} & V_{CC} = 5.5V; V_0 = 5.5V; V_0 = 0.0V; V_1 = V_{IL} \text{ or } V_{IH} & 1.0 & 10 & 10 \\ \hline \textbf{3-State output Low current} & V_{CC} = 5.5V; V_0 = 5.5V; V_0 = 5.5V; V_0 = 0.0V; V_1 = V_{IL} \text{ or } V_{IH} & -1.0 & -10 & -10 \\ \hline \textbf{0utput High leakage current} & V_{CC} = 5.5V; V_0 = 5.5V; V_0 = 5.5V; V_0 = 0.0V; V_1 = 0.0V;$

NOTES:

- 1. Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

- This is the increase in supply current for each input at 3.4V.
 For valid test results, data must not be loaded into the flip-flops (or latches) after applying the power.
 This parameter is valid for any V_{CC} between 0 and 2.1V. When the part enables with V_{CC} between 2.1V and 4.5V, the outputs will correctly function with respect to all input logic states.
- 5. This is the bus hold overdrive current required to force the input to the opposite logic state.

 $\begin{array}{l} \textbf{AC CHARACTERISTICS} \\ \textbf{GND} = \textbf{0V}, \, \textbf{t}_{R} = \textbf{t}_{F} = 2.5 \text{ns}, \, \textbf{C}_{L} = 50 \text{pF}, \, \textbf{R}_{L} = 500 \Omega \\ \end{array}$

					LIMITS			
SYMBOL	PARAMETER	WAVEFORM	٦	V _{CC} = +2500	C '	T _{amb} = -40 V _{CC} = +5	UNIT	
			MIN	TYP	MAX	MIN	MAX	
f _{MAX}	Maximum clock frequency	1	125			125		MHz
t _{PLH} t _{PHL}	Propagation delay nCPAB to nBx or nCPBA to nAx	1	1.5 1.5	3.3 2.8	4.0 4.1	1.5 1.5	4.9 4.7	ns
t _{PLH} t _{PHL}	Propagation delay nAx to nBx or nBx to nAx	2	1.0 1.0	2.3 1.8	3.2 4.1	1.0 1.0	3.9 4.6	ns
t _{PLH} t _{PHL}	Propagation delay nSAB to nBx or nSBA to nAx	3	1.0 1.0	3.4 2.6	4.3 4.3	1.0 1.0	5.0 5.0	ns
t _{PZH} t _{PZL}	Output enable time nOEBA to nAx	5 6	1.0 1.5	2.5 2.2	4.1 4.4	1.0 1.5	5.0 5.3	ns
t _{PHZ} t _{PLZ}	Output disable time nOEBA to nAx	5 6	1.5 1.5	3.6 2.7	4.4 3.6	1.5 1.5	4.9 4.0	ns
t _{PZH} t _{PZL}	Output enable time nOEAB to nBx	5 6	1.0 1.5	2.9 3.0	3.6 3.9	1.0 1.5	4.2 4.6	ns
t _{PHZ} t _{PLZ}	Output disable time nOEAB to nBx	5 6	2.0 1.5	3.1 2.3	5.5 4.5	2.0 1.5	5.9 5.2	ns

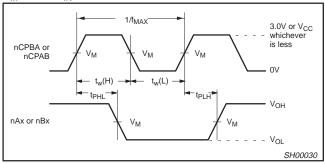
AC SETUP REQUIREMENTS

GND = 0V, t_R = t_F = 2.5ns, C_L = 50pF, R_L = 500 Ω

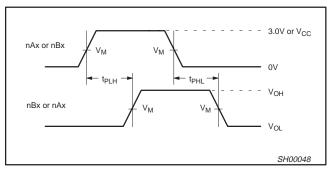
				LIMIT	rs .		
SYMBOL	PARAMETER	WAVEFORM	T _{amb} = V _{CC} =	: +25°C : +5.0V	T_{amb} = -40 to +85°C V_{CC} = +5.0V ±0.5V	UNIT	
			MIN	TYP	MIN		
$t_{s}(H)$ $t_{s}(L)$	Setup time nAx to nCPBA, nBx to nCPAB	4	3.0 3.0	1.2 0.8	3.0 3.0	ns	
t _h (H) t _h (L)	Hold time nAx to nCPBA, nBx to nCPAB	4	1.0 1.0	-0.7 -1.1	1.0 1.0	ns	
t _w (H) t _w (L)	Pulse width, High or Low nCPAB or nCPBA	1	4.3 4.3	1.0 1.0	4.3 4.3	ns	

AC WAVEFORMS

 $V_M = 1.5V$, $V_{IN} = GND$ to 3.0V



Waveform 1. Propagation Delay, Clock Input to Output, Clock **Pulse Width, and Maximum Clock Frequency**



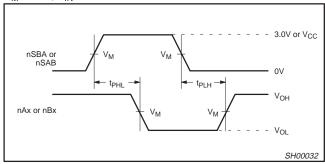
Waveform 2. Propagation Delay, nAx to nBx or nBx to nAx

16-bit transceiver/register, non-inverting (3-State)

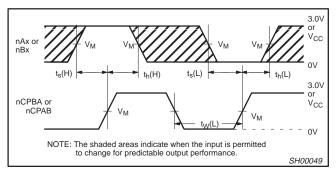
74ABT16652 74ABTH16652

AC WAVEFORMS (Continued)

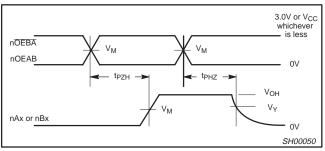
 $V_M = 1.5V$, $V_{IN} = GND$ to 3.0V



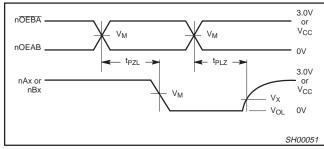
Waveform 3. Propagation Delay, SBA to nAx or SAB to nBx



Waveform 4. Data Setup and Hold Times

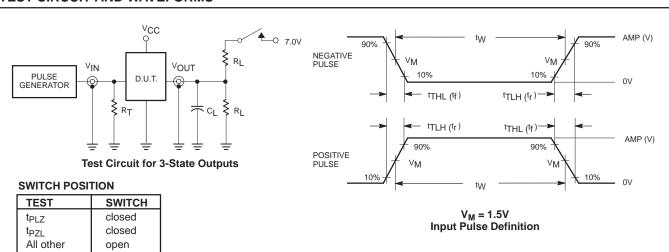


Waveform 5. 3-State Output Enable Time to High Level and Output Disable Time from High Level



Waveform 6. 3-State Output Enable Time to Low Level and Output Disable Time from Low Level

TEST CIRCUIT AND WAVEFORMS



DEFINITIONS:

 R_L = Load resistor; see AC CHARACTERISTICS for value.

C_L = Load capacitance includes jig and probe capacitance; see AC CHARACTERISTICS for value.

 $R_T = \mbox{Termination resistance should be equal to Z_{OUT} of pulse generators.}$

FAMILY	INPUT PULSE REQUIREMENTS									
PAWILT	Amplitude	Rep. Rate	t _w	t _R	t _F					
74ABT16	3.0V	1MHz	500ns	2.5ns	2.5ns					

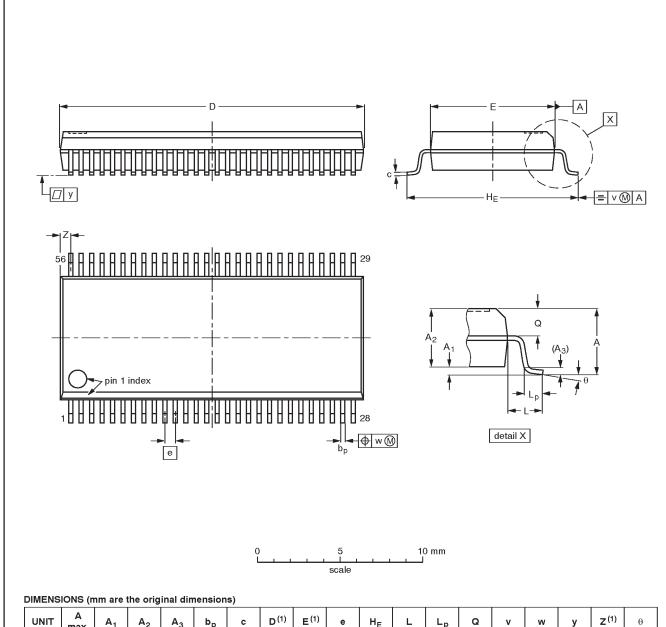
SH00022

16-bit transceiver/register, non-inverting (3-State)

74ABT16652 74ABTH16652

SSOP56: plastic shrink small outline package; 56 leads; body width 7.5 mm

SOT371-1



UNIT	A max.	Α ₁	A ₂	A ₃	рb	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	2.8	0.4 0.2	2.35 2.20	0.25	0.3 0.2	0.22 0.13	18.55 18.30	7.6 7.4	0.635	10.4 10.1	1.4	1.0 0.6	1.2 1.0	0.25	0.18	0.1	0.85 0.40	8° 0°

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	REFERENCES		EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE	
SOT371-1		MO-118AB				93-11-02 95-02-04	

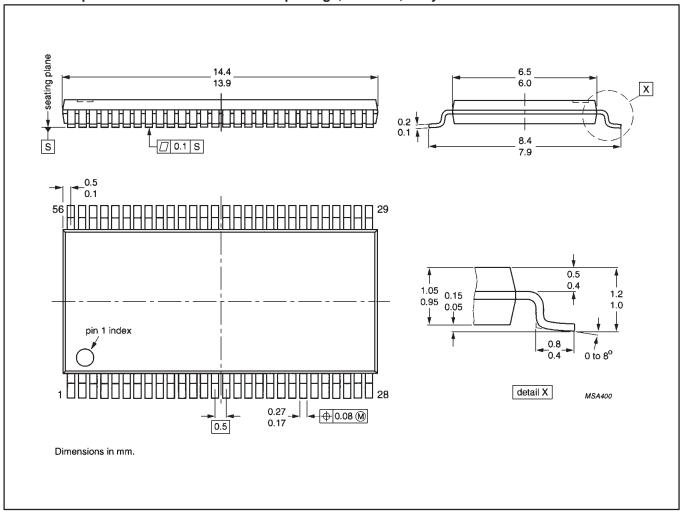
1998 Feb 27 10

16-bit transceiver/register, non-inverting (3-State)

74ABT16652 74ABTH16652

TSSOP56: plastic thin shrink small outline package; 56 leads; body width 6.1mm

SOT364-1



16-bit transceiver/register, non-inverting (3-State)

74ABT16652 74ABTH16652

Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make chages at any time without notice in order to improve design and supply the best possible product.
Product specification	Production	This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.

^[1] Please consult the most recently issued datasheet before initiating or completing a design.

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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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